

September 1983 Revised February 1999

MM74HC14

Hex Inverting Schmitt Trigger

General Description

The MM74HC14 utilizes advanced silicon-gate CMOS technology to achieve the low power dissipation and high noise immunity of standard CMOS, as well as the capability to drive 10 LS-TTL loads.

The 74HC logic family is functionally and pinout compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical propagation delay: 13 ns
- Wide power supply range: 2-6V
- Low quiescent current: 20 µA maximum (74HC Series)
- Low input current: 1 µA maximum
- Fanout of 10 LS-TTL loads
- Typical hysteresis voltage: 0.9V at V_{CC} = 4.5V

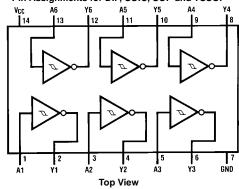
Ordering Code:

Order Number	Package Number	Package Description
MM74HC14M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
MM74HC14SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC14MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC14N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

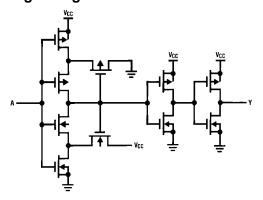
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP



Logic Diagram



Absolute Maximum Ratings(Note 1)

(Note 2)

DC Output Current, per pin (I_{OUT}) ±25 mA

DC V_{CC} or GND Current, per pin

 $\begin{array}{c} (\rm I_{CC}) & \pm 50 \; mA \\ \\ \text{Storage Temperature Range } (\rm T_{STG}) & -65^{\circ}C \; to \; +150^{\circ}C \end{array}$

Power Dissipation (P_D)

(Note 3) 600 mW S.O. Package only 500 mW

Lead Temperature (T_L)

(Soldering 10 seconds)

Recommended Operating Conditions

 $\begin{array}{c|cccc} \textbf{Min} & \textbf{Max} & \textbf{Units} \\ \textbf{Supply Voltage (V_{CC})} & 2 & 6 & V \\ \textbf{DC Input or Output Voltage} & 0 & V_{CC} & V \\ \hline (V_{IN}, V_{OUT}) & & & \\ \textbf{Operating Temperature Range (T_A)} & -40 & +85 & ^{\circ}\text{C} \\ \end{array}$

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: –

12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	v _{cc}	T _A = 25°C		T _A = -40 to 85°C	$T_A = -55$ to $125^{\circ}C$	Units
Cynnbon				Тур		Guaranteed L	imits	Ollika
V_{T+}	Positive Going	Minimum	2.0V	1.2	1.0	1.0	1.0	V
	Threshold Voltage		4.5V	2.7	2.0	2.0	2.0	V
			6.0V	3.2	3.0	3.0	3.0	V
		Maximum	2.0V	1.2	1.5	1.5	1.5	V
			4.5V	2.7	3.15	3.15	3.15	V
			6.0V	3.2	4.2	4.2	4.2	V
V_{T-}	Negative Going	Minimum	2.0V	0.7	0.3	0.3	0.3	V
	Threshold Voltage		4.5V	1.8	0.9	0.9	0.9	V
			6.0V	2.2	1.2	1.2	1.2	V
		Maximum	2.0V	0.7	1.0	1.0	1.0	V
			4.5V	1.8	2.2	2.2	2.2	V
			6.0V	2.2	3.0	3.0	3.0	V
V_{H}	Hysteresis Voltage	Minimum	2.0V	0.5	0.2	0.2	0.2	V
			4.5V	0.9	0.4	0.4	0.4	V
			6.0V	1.0	0.5	0.5	0.5	V
		Maximum	2.0V	0.5	1.0	1.0	1.0	V
			4.5V	0.9	1.4	1.4	1.4	V
			6.0V	1.0	1.5	1.5	1.5	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IL}$	2.0V	2.0	1.9	1.9	1.9	V
	Output Voltage	$ I_{OUT} = 20 \mu A$	4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IL}$						
		$ I_{OUT} = 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT} = 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$	2.0V	0	0.1	0.1	0.1	V
	Output Voltage	$ I_{OUT} = 20 \mu A$	4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$						
		$ I_{OUT} = 4.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} = 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input Current	V _{IN} = V _{CC} or GND	6.0V		±0.1	±1.0	±1.0	μΑ
I _{CC}	Maximum Quiescent	$V_{IN} = V_{CC}$ or GND	6.0V		2.0	20	40	μΑ
	Supply Current	$I_{OUT} = 0 \mu A$						

260°C

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units
t _{PHL} , t _{PLH}	Maximum Propagation Delay		12	22	ns

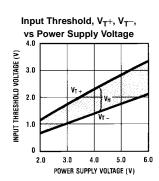
AC Electrical Characteristics

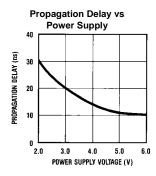
 $V_{CC} = 2.0 \text{V}$ to 6.0V, $C_L = 50 \text{ pF}$, $t_r = t_f = 6 \text{ ns}$ (unless otherwise specified)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		T _A = -40 to 85°C	T _A = -55 to 125°C	Units	
				Typ Guaranteed Limits				Oilles	
t_{PHL} , t_{PLH}	Maximum Propagation		2.0V	60	125	156	188	ns	
	Delay		4.5V	13	25	31	38	ns	
			6.0V	11	21	26	32	ns	
t_{TLH} , t_{THL}	Maximum Output Rise		2.0V	30	75	95	110	ns	
	and Fall Time		4.5V	8	15	19	22	ns	
			6.0V	7	13	16	19	ns	
C _{PD}	Power Dissipation	(per gate)		27				pF	
	Capacitance (Note 5)								
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF	

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC} 2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

Typical Performance Characteristics





Typical Applications

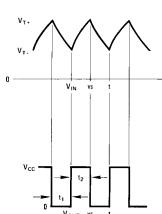
Low Power Oscillator



$$t_1 \approx RC \ln \frac{V_{T+}}{V_{T-}}$$

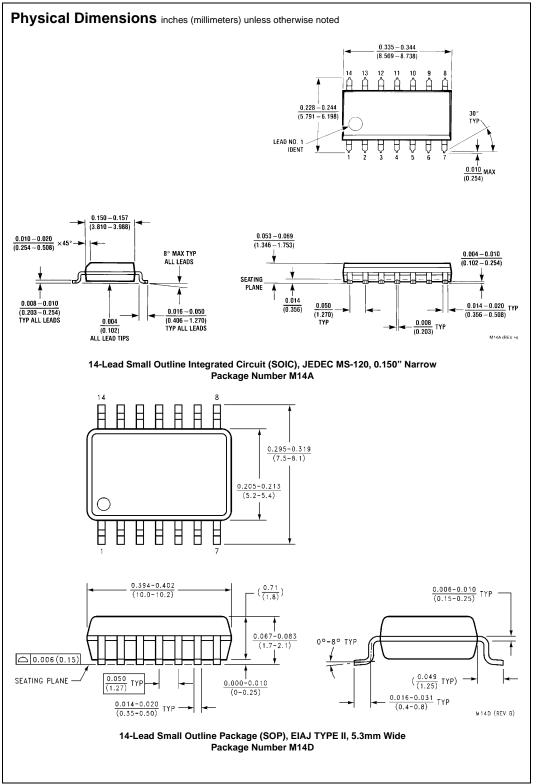
$$t_2 \approx RC \ln \frac{V_{CC} - V_{T-}}{V_{CC} - V_{T-}}$$

V_{cc} -----



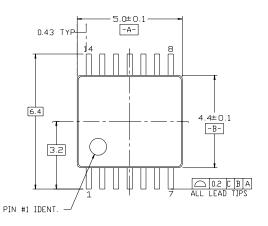
$$f \approx \frac{1}{RC \ln \frac{V_{T+}(V_{CC} - V_{T-})}{V_{T-}(V_{CC} - V_{T+})}}$$

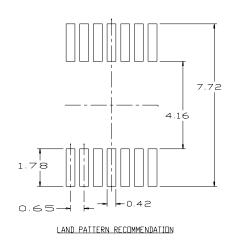
Note: The equations assume $\rm t_1\!\!+t_2>>t_{pd0}+t_{pd1}$

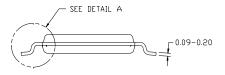


Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE

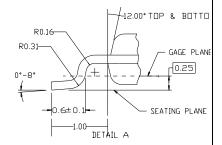




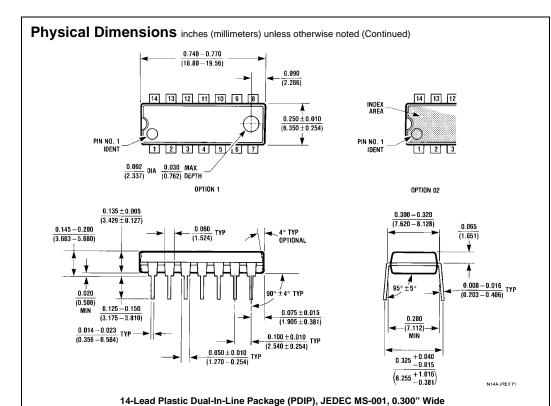


NOTES

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB., REF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14



Package Number N14A

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